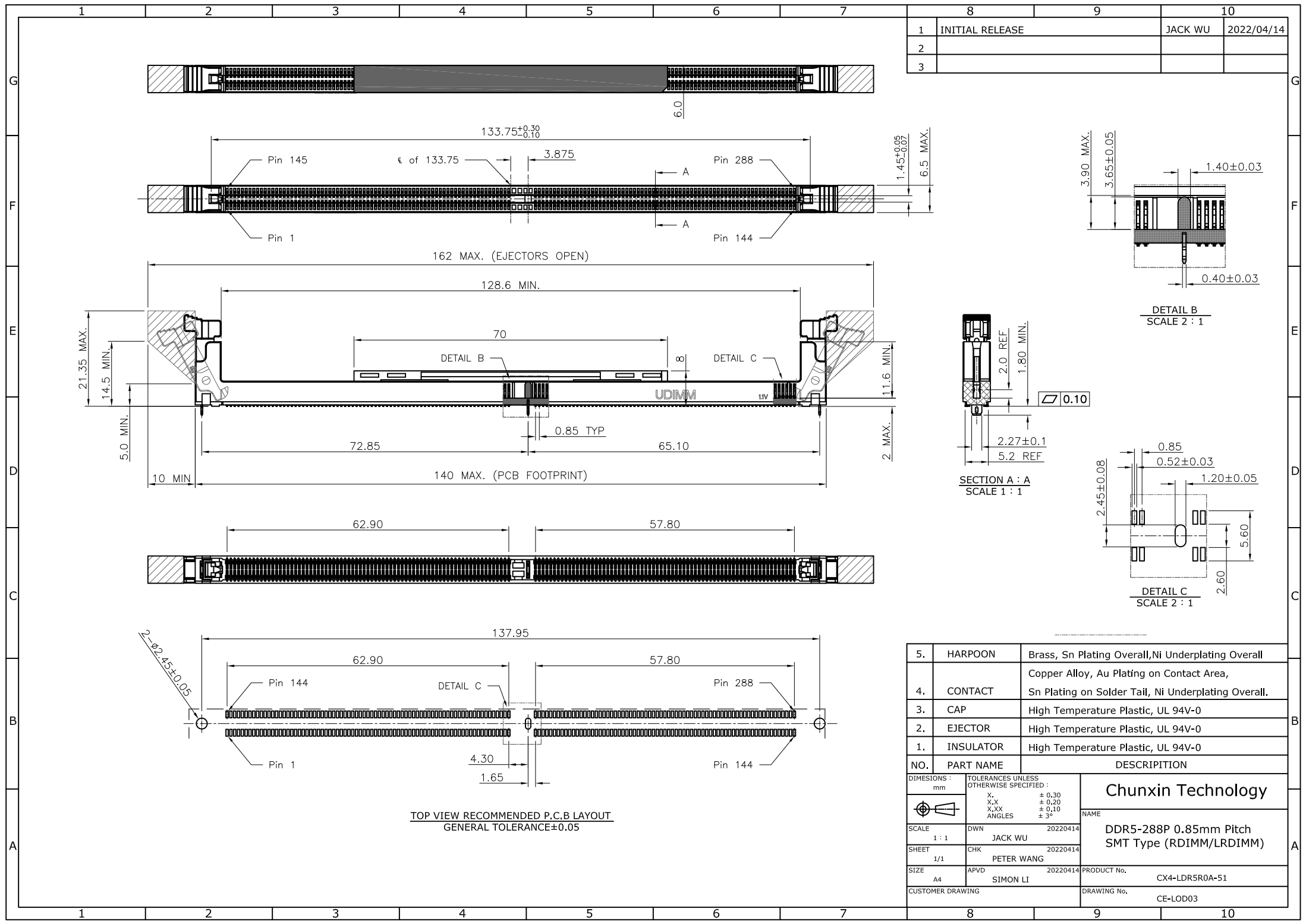
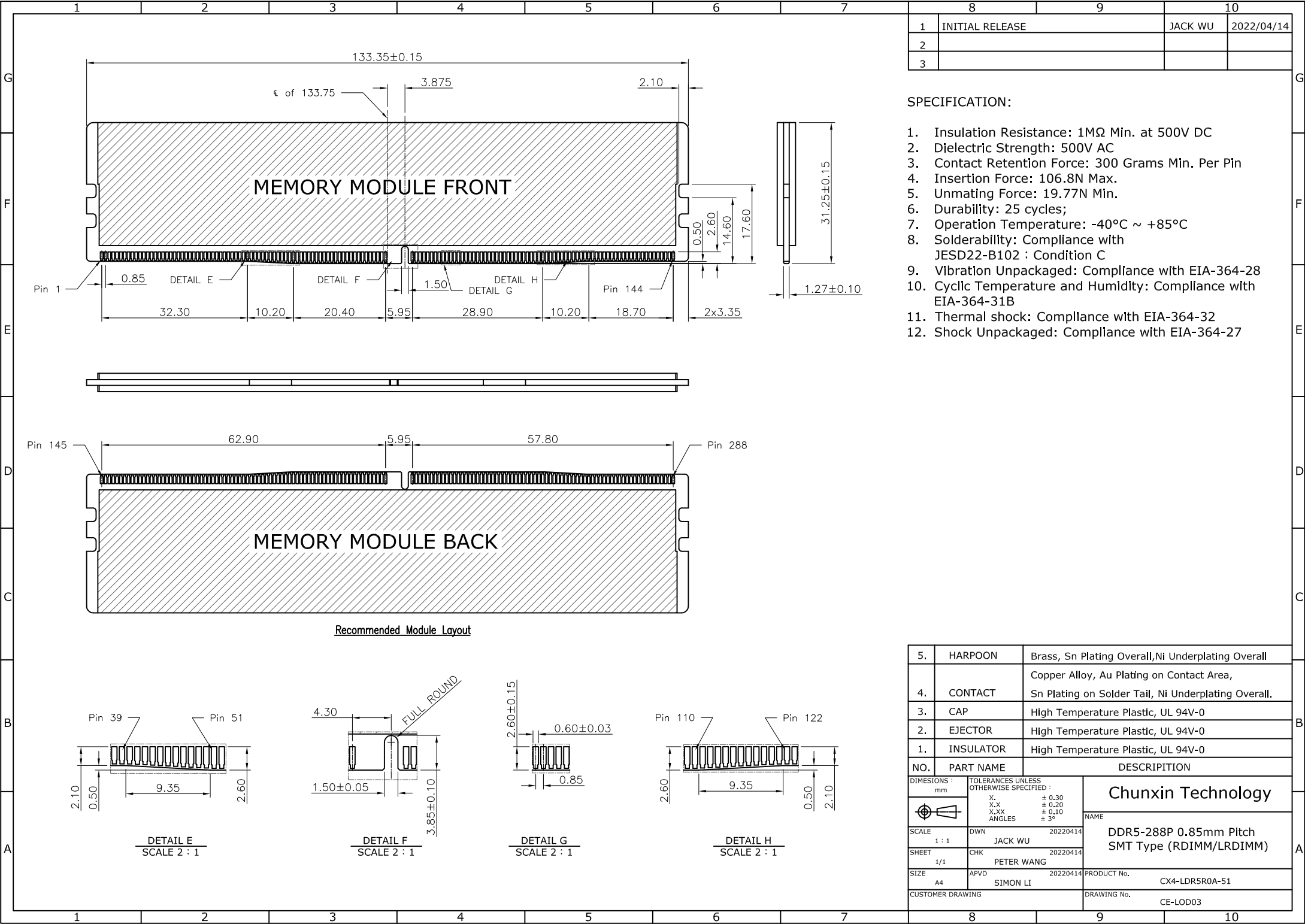






SPECIFICATION:

1. Insulation Resistance: 1MΩ Min. at 500V DC
2. Dielectric Strength: 500V AC
3. Contact Retention Force: 300 Grams Min. Per Pin
4. Insertion Force: 106.8N Max.
5. Unmating Force: 19.77N Min.
6. Durability: 25 cycles;
7. Operation Temperature: -40°C ~ +85°C
8. Solderability: Compliance with JESD22-B102 ; Condition C
9. Vibration Unpackaged: Compliance with EIA-364-28
10. Cyclic Temperature and Humidity: Compliance with EIA-364-31B
11. Thermal shock: Compliance with EIA-364-32
12. Shock Unpackaged: Compliance with EIA-364-27

5.	HARPOON	Brass, Sn Plating Overall,Ni Underplating Overall		
4.	CONTACT	Copper Alloy, Au Plating on Contact Area, Sn Plating on Solder Tail, Ni Underplating Overall.		
3.	CAP	High Temperature Plastic, UL 94V-0		
2.	EJECTOR	High Temperature Plastic, UL 94V-0		
1.	INSULATOR	High Temperature Plastic, UL 94V-0		
NO.	PART NAME	DESCRIPTION		
DIMENSIONS : mm		TOLERANCES UNLESS OTHERWISE SPECIFIED : X. ± 0.30 X.X ± 0.20 X.XX ± 0.10 ANGLES ± 3°		
SCALE 1 : 1		DWN JACK WU 20220414		
SHEET 1/1		CHK PETER WANG 20220414		
SIZE A4		APVD SIMON LI 20220414		
CUSTOMER DRAWING		DRAWING No. CE-LOD03		
		NAME Chunxin Technology		
		PRODUCT No. CX4-LDR5R0A-51		
		SMT Type (RDIMM/LRDIMM)		